Electronic Acknowledgement Receipt		
EFS ID:	9652991	
Application Number:	09684519	
International Application Number:		
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Title of Invention:	THERMALLY COMPLIANT PCB SUBSTRATE FOR THE APPLICATION OF CHIP SCALE PACKAGES	
First Named Inventor/Applicant Name:	Jin-Yuan Lee	
Customer Number:	28112	
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1		POAFee Address Form 373B-085 027-0031.pdf	298876 e77c729d9b970c9cd043165d2c85802753d	yes	4

Multipart Description/PDF files in .zip description			
Document Description	Start	End	
Miscellaneous Incoming Letter	1	1	
Miscellaneous Incoming Letter	2	2	
Power of Attorney	3	3	
Assignee showing of ownership per 37 CFR 3.73(b).	4	4	

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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

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